Electronic Patent Application Fee Transmittal						
Application Number:	10541586					
Filing Date:	30-Sep-2005					
Title of Invention:	she	Curing resin composition, adhesive epoxy resin paste, adhesive epoxy resin sheet, conductive connection paste, conductive connection sheet, and electronic component joined body				
First Named Inventor/Applicant Name:	Koji Watanabe					
Filer:	Joseph J. Ruch/Emily English					
Attorney Docket Number:	Q88153					
Filed as Large Entity						
U.S. National Stage under 35 USC 371 Filing	Fee	s				
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						
Extension - 3 months with \$0 paid		1253	1	1110	1110	

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			1110